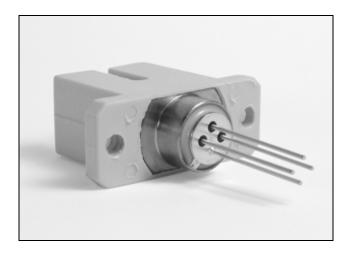


2.5 Gbps, 1310 nm Uncooled Fabry-Perot Laser Diode Module with Monitor

Data Sheet

December 2003



Features

- Uncooled 1300 nm Fabry-Perot Laser Diode
- Wide operating temperature range -40°C to +85°C
- · High reliability
- Built-in monitor diode
- 2.5 Gbps
- · Ball lens or receptable type of packaging

Ordering Information

ZL60402TBD TO-56 with lens
ZL60402TDD ST type connector
ZL60402TED SC type connector
ZL60402TFD FC type connector

-40°C to +85°C

Description

The Fabry-Perot Laser Diode Receptacle type series is designed for use with SC, FC and ST type fiber connectors as source in telecom and datacom applications.

The ZL60402 is a 1310 nm MQW (Multiple Quantum Well) Fabry-Perot laser diode, integrated with a monitor diode.

The hermatically sealed package includes a ball lens for improved coupling efficiency.

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Applications

- Telecommunications applications, SONET OC-48, SDH STM-16
- Optical communications systems

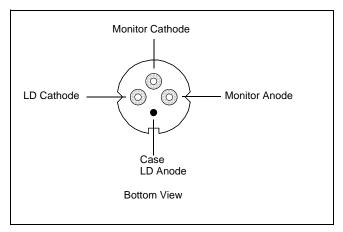


Figure 1 - PIN Diagram

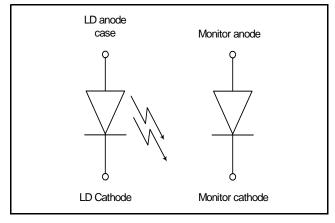


Figure 2 - Functional Schematic

ZL60402 Data Sheet

Electrical and Optical Characteristics ($T_C = 25^{\circ}C$)

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Threshold Current	I _{th}	CW		10	15	mA
Operating Voltage	V _{op}	CW, $I_f = I_{th} + 20 \text{ mA}$		1.3	1.5	V
Optical Output Power	P _f	CW, $I_f = I_{th} + 20 \text{ mA}$		0.6		mW
Wavelength	λ	CW, I _{th} +20 mA	1290	1310	1330	nm
Spectral Width	Δλ	CW, I _{th} +20 mA		1	3	nm
Rise and Fall Times	t _r , t _f	$I_f = I_{th} + 20 \text{ mA},$ 20-80%			150	ps
Tracking Error	ΔP _f /P _f	APC, 0 - +70°C	-1.5		1.5	dB
		-40°C - +85°C	-2.5		2.5	
Monitor Current	I _D	CW, I_{th} +20 mA, V_{RD} = 1 V	100			μΑ
Monitor Dark Current	I _D	V _{RD} = 5 V			1	μA
Monitor Capacitance	C _D	V _{RD} = 5 V, f = 1 MHz		10	15	pF

Absolute Maximum Ratings

Parameter	Symbol	Rating	Unit
LD Reverse Voltage	V _{RL}	2	V
PD Reverse Voltage	V _{RD}	20	V
PD Forward Current	I _f	2.0	mA
Operating Temperature	T _{op}	-40 - +85	°C
Storage Temperature	T _{stg}	-40 - +85	°C

ZL60402 Data Sheet

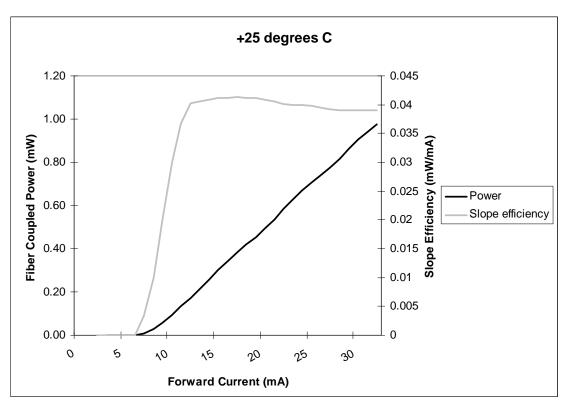


Figure 3 - Typical Fiber Coupled Power and Slope Efficiency at Room Temperature

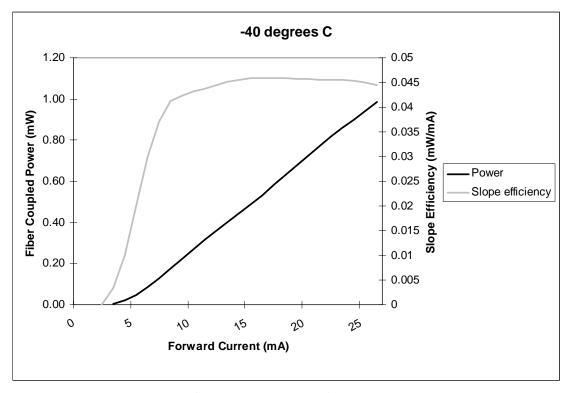


Figure 4 - Typical Fiber Coupled Power and Slope Efficiency at Low Temperature

ZL60402 Data Sheet

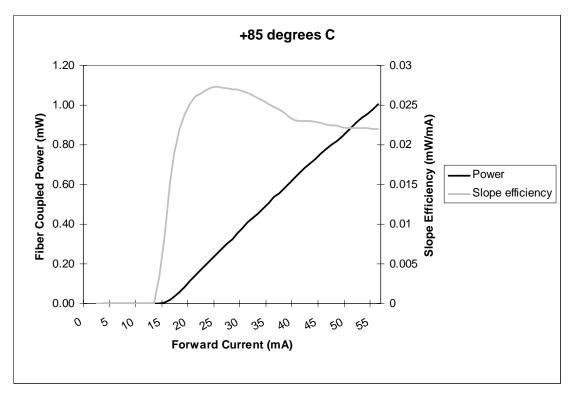
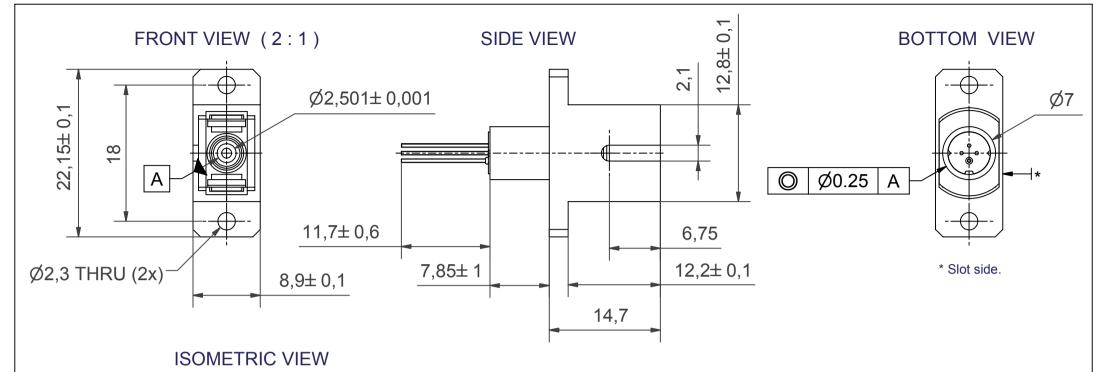
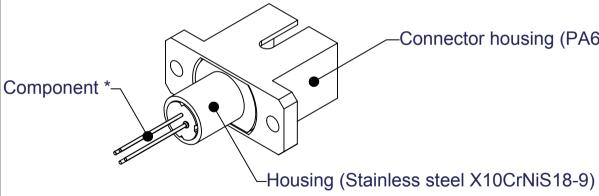


Figure 5 - Typical Fiber Coupled Power and Slope Efficiency at High Temperature





-Connector housing (PA66, 13% Glass fibre)

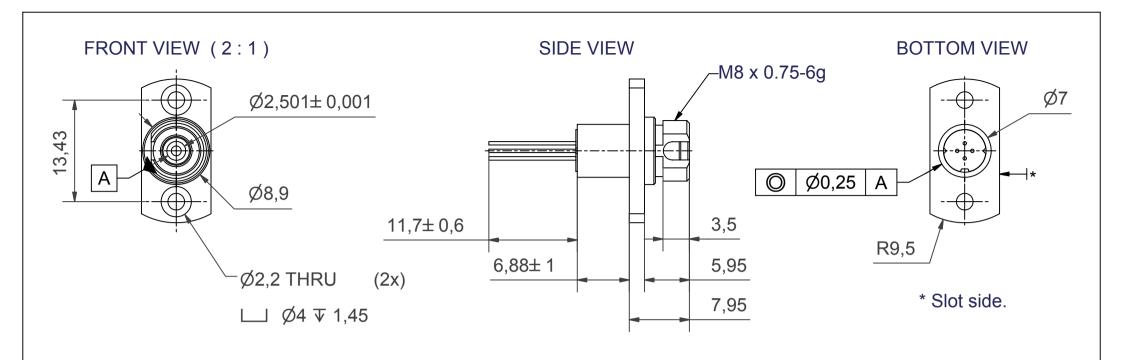
NOTES:-

- 1. All dimensions in mm.
- 2. General tol. ISO-2768-mK.

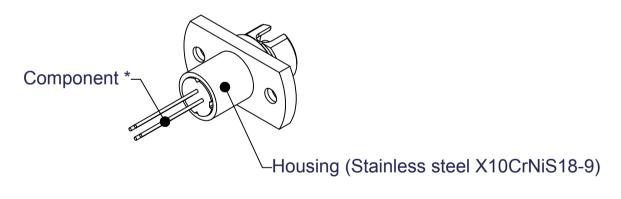


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ISSUE	1					Previous package codes	Drawing type
ACN	101512rev 1				EXECUTE ZARLINK		TO-56 Package Outline in SC Connector housing
DATE	17-NOV-03				SEMICONDUCTOR		Title
APPRD.	PD\US						101512

^{*} For details of the component, see separate data sheet and/or package drawing.



ISOMETRIC VIEW



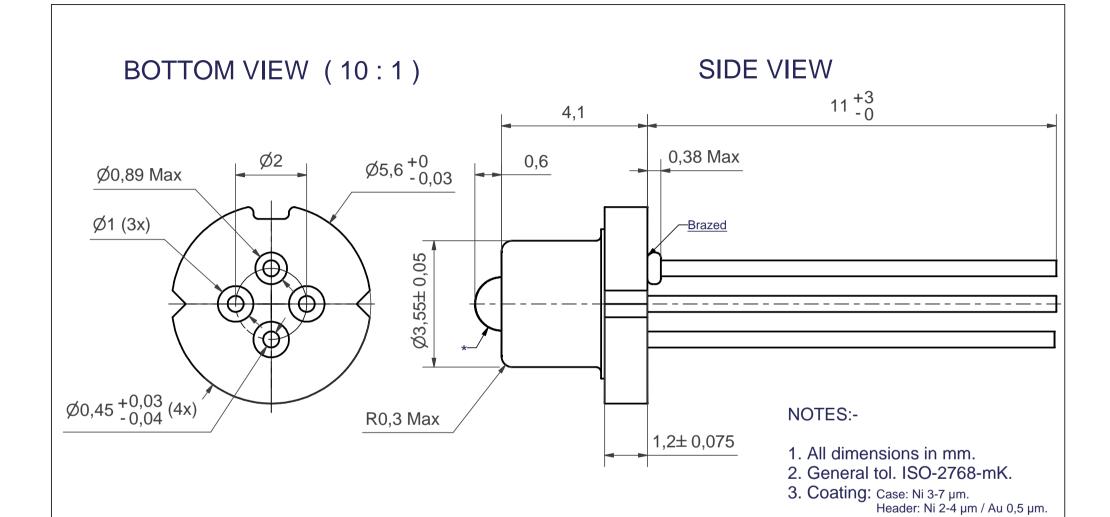
NOTES:-

- 1. All dimensions in mm.
- 2. General tol. ISO-2768-mK.

Projection 🚭

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ISSUE	1					Previous package codes	Drawing type
ACN	101513 rev1				ZARLINK		TO-56 Package Outline in FC Connector housing
DATE	17-NOV-03				SEMICONDUCTOR		Title
APPRD.	PD\US						101513

^{*} For details of the component, see separate data sheet and/or package drawing.



* Lens Ø1,5± 0,002

101615 rev1

21-NOV-03

APPRD. MD/MA

ISSUE

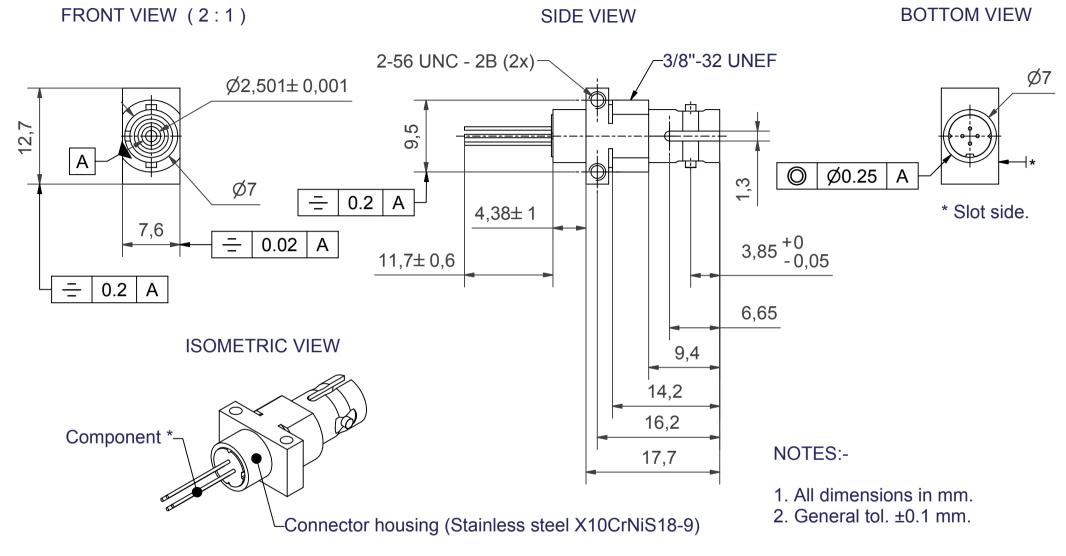
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DATE

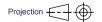
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		Package code TB
ZARLINK SEMICONDUCTOR	Previous package codes	Package Drawing, TO-56 with lens
		Title 101615

Projection Method



^{*} For details of the component, see separate data sheet and/or package drawing.



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ISSUE	1					Previous package codes	Drawing type
ACN	101514 rev1				ZARLINK		TO-56 Package Outline in ST Connector housing
DATE	17-NOV-03				SEMICONDUCTOR		Title
APPRD.	PD\US						101514



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